

RQ6E080AJ

Nch 30V 8A Small signal MOSFET

Datasheet

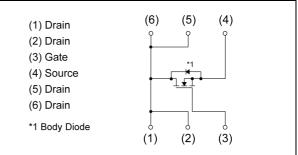
V _{DSS}	30V
R _{DS(on)} (Max.)	16.5mΩ
I _D	±8.0A
P _D	1.25W

2) Small Surface Mount Package (TSMT6)

3) Pb-free lead plating ; RoHS compliant

• Outline SOT-457T SC-95 TSMT6

Inner circuit



Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	180
Туре	Tape width (mm)	8
	Quantity (pcs)	3000
	Taping code	TCR
	Marking	HS

● Absolute maximum ratings (T₂ = 25°C, unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	30	V
Continuous drain current	I _D	±8.0	А
Pulsed drain current	I _{DP} *1	±18	А
Gate - Source voltage	V _{GSS}	±12	V
Avalanche current, single pulse	I _{AS} *2	8.0	А
Avalanche energy, single pulse	E _{AS} *2	4.7	mJ
Dower discipution	P _D *3	1.25	W
Power dissipation	P _D ^{*4}	0.95	W
Junction temperature	Tj	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

Application

Switching

Features

1) Low on - resistance

Thermal resistance

Deremeter	Symbol	Values			1 1
Parameter		Min.	Тур.	Max.	Unit
Thermal registeres junction embient	R_{thJA}^{*3}	-	-	100	°C/W
Thermal resistance, junction - ambient	R_{thJA}^{*4}	-	-	132	°C/W

• Electrical characteristics (T_a = 25°C)

Deremeter	Sumbol	Conditions	Values			Lincit
Parameter Symbol Conditions		Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		30	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{i}} I_{D} = 1 \text{mA}$ referenced to 25°C		18	-	mV/°C
Zero gate voltage drain current	I _{DSS}	V _{DS} = 30V, V _{GS} = 0V	-	-	1	μA
Gate - Source leakage current	I_{GSS} $V_{GS} = \pm 12V, V_{DS} = 0V$		-	-	±100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 2mA$	0.5	-	1.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_{j}} I_{D} = 2mA$ referenced to 25°C		-	-1.8	-	mV/°C
Static drain - source	D *5	V _{GS} = 4.5V, I _D = 8.0A	-	12.5	16.5	
on - state resistance	${R_{DS(on)}}^{*5}$	V _{GS} = 2.5V, I _D = 4.0A	-	15.7	19.5	mΩ
Gate resistance	R_G f = 1MHz, open drain		-	1.9	-	Ω
Forward Transfer Admittance	Y _{fs} * ⁵	V _{DS} = 5V, I _D = 8A	10	-	-	S

*1 Pw \leq 10µs, Duty cycle \leq 1%

*2 L \simeq 0.1mH, V_{DD} = 15V, R_G = 25 Ω , Starting T_j = 25°C Fig.3-1,3-2

- *3 Mounted on a ceramic boad (30×30×0.8mm)
- *4 Mounted on a FR4 (25×25×0.8mm)
- *5 Pulsed



• Electrical characteristics ($T_a = 25^{\circ}C$)

Deremeter	Sumpleal	Conditions	Values			1.1
Parameter	Symbol	mbol Conditions –		Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V	-	1810	-	
Output capacitance	C _{oss}	V _{DS} = 15V	-	210	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	140	-	
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 15 V, V_{GS} = 4.5 V$	-	20	-	
Rise time	t _r *5	I _D = 4.0A	-	16	-	20
Turn - off delay time	$t_{d(off)}^{*5}$	R _L ≃ 3.75Ω	-	65	-	ns
Fall time	t _f *5	R _G = 10Ω	-	22	-	

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Symbol	Conditions	Values			Unit
Parameter	Symbol	Symbol Conditions -		Тур.	Max.	Unit
Total gate charge	Q_g^{*5}	V _{DD} ≃ 15V,	-	16.2	-	
Gate - Source charge	Q_{gs}^{*5}	I _D = 8A, V _{GS} = 4.5V	-	4.2	-	nC
Gate - Drain charge	Q _{gd} *5	V _{GS} = 4.5V	-	4.0	-	

•Body diode electrical characteristics (Source-Drain) ($T_a = 25^{\circ}C$)

Parameter	Sympol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	۱ _s	$T = 25^{\circ}$	-	-	1.0	А
Pulse forward current	I _{SP} *1	T _a = 25°C	-	-	18	А
Forward voltage	V_{SD}^{*5}	V _{GS} = 0V, I _S = 1.0A	-	-	1.2	V



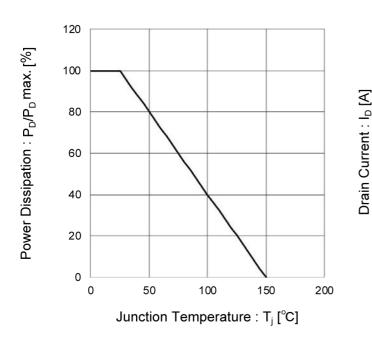
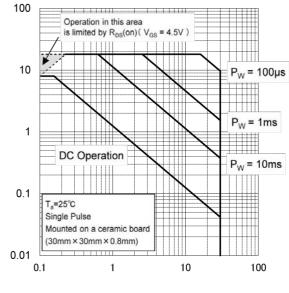
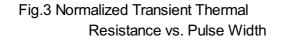


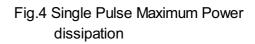
Fig.1 Power Dissipation Derating Curve

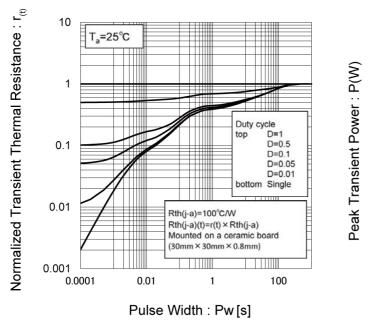
Fig.2 Maximum Safe Operating Area



Drain - Source Voltage : V_{DS} [V]

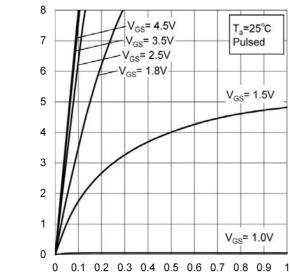






Pulse Width : Pw [s]





Drain Current : I_D [A]

Fig.5 Typical Output Characteristics(I)

'_{GS}= 4.5V

V_{GS}= 3.5V

V_{GS}= 2.5V

V_{GS}= 1.8V

T_a=25°C

Drain Current : I_D [A]

Pulsed

V_{GS}= 1.5V

V_{GS}= 1.0V

Fig.6 Typical Output Characteristics(II)

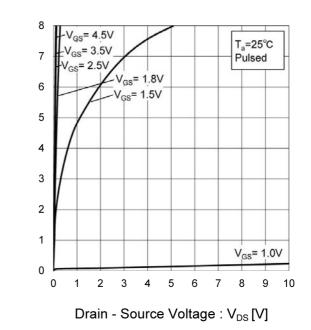
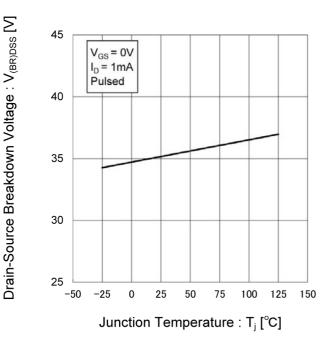


Fig.7 Breakdown Voltage vs. Junction Temperature

Drain - Source Voltage : V_{DS} [V]



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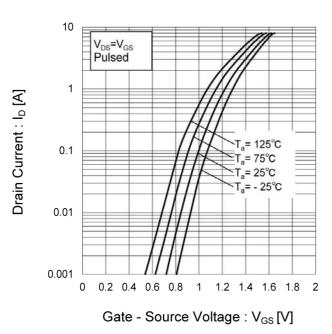


Fig.8 Typical Transfer Characteristics

Fig.9 Gate Threshold Voltage vs. Junction Temperature

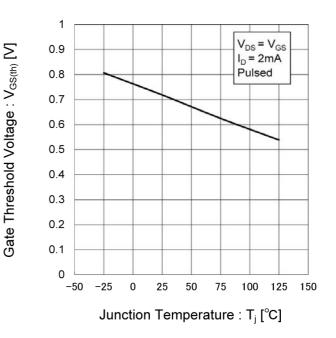
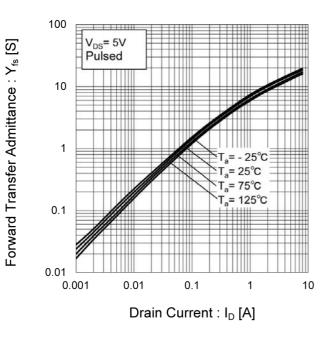


Fig.10 Forward Transfer Admittance vs. Drain Current





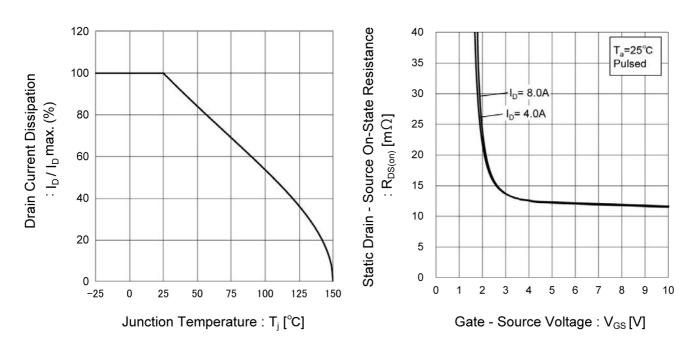


Fig.11 Drain Current Derating Curve

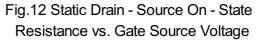


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

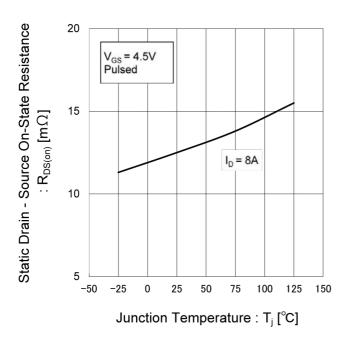




Fig.15 Static Drain - Source On - State

• Electrical characteristic curves

Fig.14 Static Drain - Source On - State

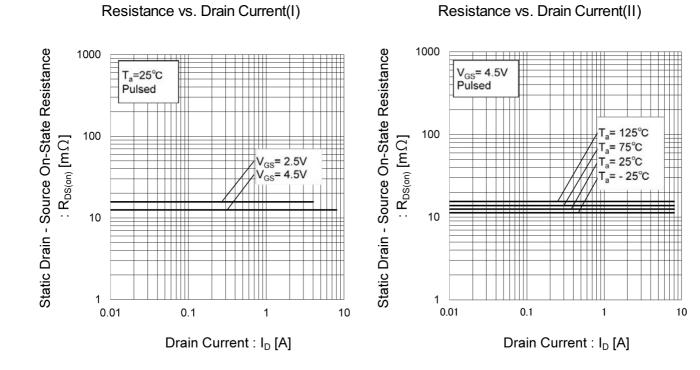
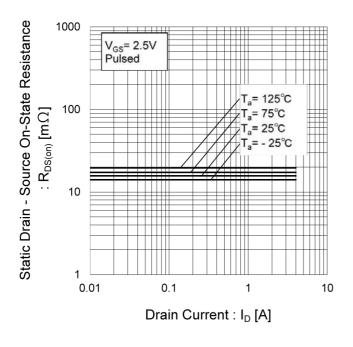


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current(III)







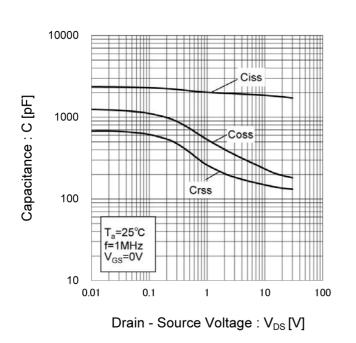


Fig.17 Typical Capacitance vs. Drain -Source Voltage

Fig.18 Switching Characteristics

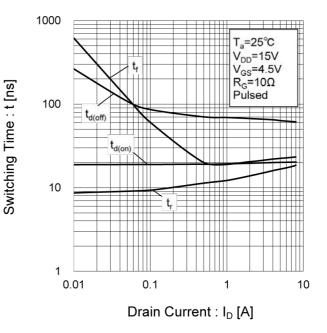


Fig.19 Dynamic Input Characteristics

Gate - Source Voltage : V_{GS} [V]

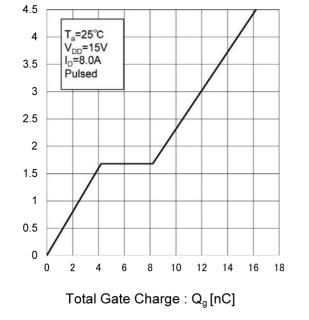
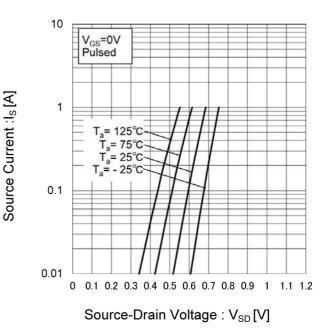


Fig.20 Source Current vs. Source Drain Voltage





Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

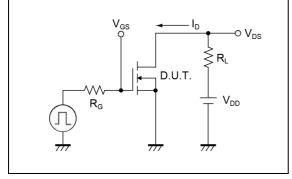


Fig.2-1 Gate Charge Measurement Circuit

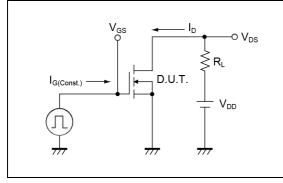


Fig.3-1 Avalanche Measurement Circuit

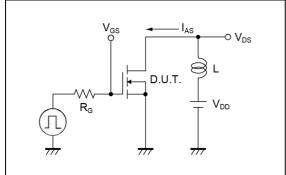


Fig.1-2 Switching Waveforms

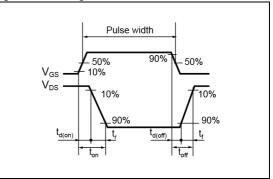


Fig.2-2 Gate Charge Waveform

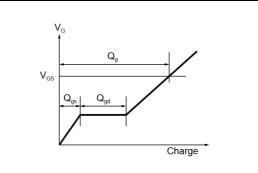
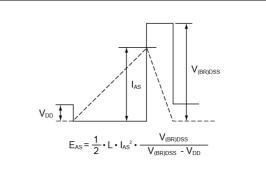


Fig.3-2 Avalanche Waveform



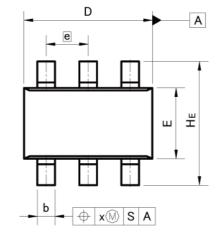
Notice

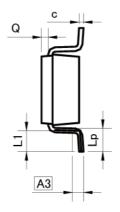
This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

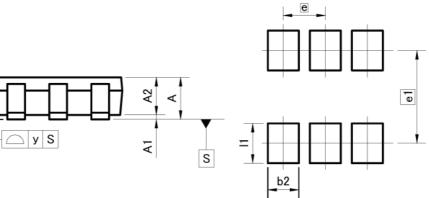


Dimensions









Pattern of terminal position areas [Not a pattern of soldering pads]

)) 0.01) 	0.020 0.010 0.118
) 0.01) 	0.004 0.037 0 0.020 0.010 0.118
) 0.01) 	0.037 0 0.020 0.010 0.118
0.01	0 0.020 0.010 0.118
4 4 1)	0.020 0.010 0.118
)	0.010
)	0.118
)	
	0.071
0.037	
2	0.118
2	0.024
5	0.028
2	0.010
	0.008
	0.004
INCH	ES
	MAX
	0.028
0.08	3

Dimension in mm/inches

-

11



0.90

-



0.035

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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